

Low Noise, Rail-to-Rail, Differential ADC Driver

AD8139

FEATURES

Fully differential

Low noise

2.25 nV/√Hz

2.1 pA/√Hz

Low harmonic distortion

98 dBc SFDR @ 1 MHz

85 dBc SFDR @ 5 MHz

72 dBc SFDR @ 20 MHz

High speed

410 MHz, 3 dB BW (G = 1)

800 V/µs slew rate

45 ns settling time to 0.01%

69 dB output balance @ 1 MHz

80 dB dc CMRR

Low offset: ±0.5 mV maximum

Low input offset current: 0.5 µA maximum

Differential input and output

 ${\bf Differential\text{-}to\text{-}differential}\ or\ single\text{-}ended\text{-}to\text{-}differential$

operation

Rail-to-rail output

Adjustable output common-mode voltage

Wide supply voltage range: 5 V to 12 V

Available in a small SOIC package and an 8-lead LFCSP

GENERAL DESCRIPTION

The AD8139 is an ultralow noise, high performance differential amplifier with rail-to-rail output. With its low noise, high SFDR, and wide bandwidth, it is an ideal choice for driving ADCs with resolutions to 18 bits. The AD8139 is easy to apply, and its internal common-mode feedback architecture allows its output common-mode voltage to be controlled by the voltage applied to one pin. The internal feedback loop also provides outstanding output balance as well as suppression of even-order harmonic distortion products. Fully differential and single-ended-to-differential gain configurations are easily realized by the AD8139. Simple external feedback networks consisting of four resistors determine the closed-loop gain of the amplifier.

The AD8139 is manufactured on the Analog Devices, Inc. proprietary, second-generation XFCB process, enabling it to achieve low levels of distortion with input voltage noise of only $2.25 \text{ nV}/\sqrt{\text{Hz}}$.

APPLICATIONS

ADC drivers to 18 bits
Single-ended-to-differential converters
Differential filters
Level shifters
Differential PCB drivers
Differential cable drivers

FUNCTIONAL BLOCK DIAGRAMS

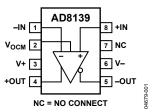


Figure 1. 8-Lead SOIC

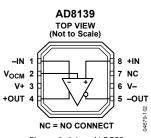


Figure 2. 8-Lead LFCSP

The AD8139 is available in an 8-lead SOIC package with an exposed paddle (EP) on the underside of its body and a 3 mm \times 3 mm LFCSP. It is rated to operate over the temperature range of -40° C to $+125^{\circ}$ C.

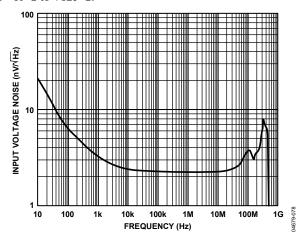


Figure 3. Input Voltage Noise vs. Frequency

IMPORTANT LINKS for the AD8139*

Last content update 10/24/2013 10:44 am

SIMILAR PRODUCTS & PARAMETRIC SELECTION TABLES

Find Similar Products By Operating Parameters

High Speed Amplifiers Selection Table

<u>ADA4932-1:</u> (single) and <u>ADA4932-2:</u> (dual): Low Cost / Low Power Differential ADC Driver

ADA4937-1: (single) and **ADA4937-2:** (dual): Ultralow Distortion Differential ADC Driver

<u>ADA4938-1:</u> (single) and <u>ADA4938-2:</u> (dual): Ultralow Distortion Differential ADC Driver

ADA4927-1: (single) and **ADA4927-2:** (dual): Ultralow Distortion Current Feedback Differential ADC Driver

<u>ADA4930-1:</u> (single) and <u>ADA4930-2:</u> (dual): Ultralow Noise Drivers for Low Voltage ADCs

DESIGN TOOLS, MODELS, DRIVERS & SOFTWARE

Analog Filter Wizard 2.0 ADI DiffAmpCalc™

AD8139 SPICE Macro Model, Rev 0,

DESIGN COLLABORATION COMMUNITY



Collaborate Online with the ADI support team and other designers about select ADI products.

Follow us on Twitter: www.twitter.com/ADI News Like us on Facebook: www.facebook.com/AnalogDevicesInc

DOCUMENTATION

AN-1026: High Speed Differential ADC Driver Design Considerations

AN-0990: Terminating a Differential Amplifier in Single-Ended Input Applications

AN-0992: Active Filter Evaluation Board for Differential Amplifiers

AN-649: Using the Analog Devices Active Filter Design Tool

AN-584: Using the AD813X Differential Amplifier

MT-218: Multiple Feedback Band-Pass Design Example

MT-076: Differential Driver Analysis

MT-075: Differential Drivers for High Speed ADCs Overview

A Stress-Free Method for Choosing High-Speed Op Amps

UG-474: Evaluation Board for Differential Amplifiers Offered in 8-Lead SOIC Packages

UG-190: Differential Amplifier Evaluation Board for Single 8-lead LFCSP Packages

UG-130: Differential Amplifier Evaluation Board for 8-lead SOIC and MSOP Packages

Ask The Application Engineer 36, Wideband A/D Converter Front-End Design Considerations II: Amplifier-or Transformer Drive for the ADC?

"Rules of the Road" for High-Speed Differential ADC Drivers

AD8139/AD8137: Differential Amplifiers For ADC Driving

DESIGN SUPPORT

Submit your support request here: <u>Linear and Data Converters</u> <u>Embedded Processing and DSP</u>

Telephone our Customer Interaction Centers toll free:

 Americas:
 1-800-262-5643

 Europe:
 00800-266-822-82

 China:
 4006-100-006

 India:
 1800-419-0108

 Russia:
 8-800-555-45-90

Quality and Reliability Lead(Pb)-Free Data

SAMPLE & BUY

AD8139

- View Price & Packaging
- Request Evaluation Board
- Request Samples
- Check Inventory & Purchase

Find Local Distributors

EVALUATION KITS & SYMBOLS & FOOTPRINTS

View the Evaluation Boards and Kits page for documentation and purchasing

Symbols and Footprints



Features1Pin Configurations and Function DescriptionsApplications1Typical Performance CharacteristicsFunctional Block Diagrams1Test CircuitsGeneral Description1Theory of OperationRevision History2Typical Connection and Definition of TermsSpecifications3Applications $V_S = \pm 5 \text{ V}, V_{OCM} = 0 \text{ V}$ 3Estimating Noise, Gain, and Bandwidth with Mathary $V_S = 5 \text{ V}, V_{OCM} = 2.5 \text{ V}$ 5	
Functional Block Diagrams 1 Test Circuits Theory of Operation 1 Theory of Operation 2 Typical Connection and Definition of Terms 2 Typical Connection and Definition of Terms 3 Applications 4 Applications 4 Estimating Noise, Gain, and Bandwidth with Mat $V_S = 5 \text{ V}, V_{\text{OCM}} = 2.5 \text{ V}$ 5 Feedback Networks 5 On the Property of Operation 2 Theory of Operation 3 Applications 4 Applications 5 On the Property Operation 3 Applications 6 On the Property Operation 9 Operation 9 On the Property Operatio	15 18 19
General Description	18 18
Revision History	18
Specifications	19
$V_S = \pm 5 \text{ V}, V_{OCM} = 0 \text{ V}.$ Estimating Noise, Gain, and Bandwidth with Mather Value of St. V. Vocm = 2.5 V. St. St. St. St. St. St. St. St. St. St	
V _S = 5 V, V _{OCM} = 2.5 V	
V5 = 5 V, VOCM = 2.5 V	ched
O die Die on to	19
Absolute Maximum Ratings	24
Thermal Resistance Ordering Guide	2
ESD Caution7	
REVISION HISTORY	
10/07—Rev. A to Rev. B. 8/04—Rev. 0 to Rev. A.	
Changes to General Description	Universa
Inserted Figure 2; Renumbered Sequentially	
Changes to Table 1	
Changes to Table 2	
Changes to Table 6 and Layout	
nserted Figure 6; Renumbered Sequentially	
Changes to Figure 30	
Changes to Layout	12
Changes to Figure 63	14
Changes to Exposed Paddle (EP) Section	
Updated Outline Dimensions24 Inserted Figure 48	
Changes to Figure 52 and Figure 53	
Changes to Figure 55 and Figure 56	
Changes to Table 6	
Changes to Voltage Gain Section	
Changes to Driving a Capacitive Load Section	
Changes to Ordering Guide	

5/04—Revision 0: Initial Version

SPECIFICATIONS

 $V_s = \pm 5 V$, $V_{OCM} = 0 V$

 $T_{A}=25^{\circ}\text{C}, \text{ differential gain}=1, R_{L, \text{ dm}}=1 \text{ k}\Omega, R_{F}=R_{G}=200 \text{ }\Omega, \text{ unless otherwise noted.} T_{\text{MIN}} \text{ to } T_{\text{MAX}}=-40^{\circ}\text{C to } +125^{\circ}\text{C}.$

Table 1.

Parameter	Conditions	Min	Тур	Max	Unit
DIFFERENTIAL INPUT PERFORMANCE					
Dynamic Performance					
–3 dB Small Signal Bandwidth	$V_{O, dm} = 0.1 \text{ V p-p}$	340	410		MHz
–3 dB Large Signal Bandwidth	$V_{O,dm} = 2 V p-p$	210	240		MHz
Bandwidth for 0.1 dB Flatness	$V_{O, dm} = 0.1 \text{ V p-p}$		45		MHz
Slew Rate	$V_{O, dm} = 2 V step$		800		V/µs
Settling Time to 0.01%	$V_{O, dm} = 2 V \text{ step, } C_F = 2 pF$		45		ns
Overdrive Recovery Time	$G = 2$, $V_{IN, dm} = 12 V p-p$ triangle wave		30		ns
Noise/Harmonic Performance					
SFDR	$V_{O, dm} = 2 V p-p, f_C = 1 MHz$		98		dBc
	$V_{O,dm} = 2 V p-p, f_C = 5 MHz$		85		dBc
	$V_{O, dm} = 2 V p-p, f_C = 20 MHz$		72		dBc
Third-Order IMD	$V_{O, dm} = 2 V p-p, f_C = 10.05 MHz \pm 0.05 MHz$		-90		dBc
Input Voltage Noise	f = 100 kHz		2.25		nV/√Hz
Input Current Noise	f = 100 kHz		2.1		pA/√Hz
DC Performance					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 0 V$	-500	±150	+500	μV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		1.25		μV/°C
Input Bias Current	T _{MIN} to T _{MAX}		2.25	8.0	μΑ
Input Offset Current			0.12	0.5	μΑ
Open-Loop Gain			114		dB
Input Characteristics					
Input Common-Mode Voltage Range		-4		+4	V
Input Resistance	Differential		600		kΩ
	Common mode		1.5		ΜΩ
Input Capacitance	Common mode		1.2		pF
CMRR	$\Delta V_{ICM} = \pm 1 \text{ V dc}, R_F = R_G = 10 \text{ k}\Omega$	80	84		dB
Output Characteristics					
Output Voltage Swing	Each single-ended output, $R_F = R_G = 10 \text{ k}\Omega$	$-V_{s} + 0.20$		$+V_{S}-0.20$	٧
	Each single-ended output,	$-V_s + 0.15$		$+V_{S}-0.15$	V
	$R_{L,dm}$ = open circuit, $R_F = R_G = 10 \text{ k}\Omega$				
Output Current	Each single-ended output		100		mA
Output Balance Error	f = 1 MHz		-69		dB
V _{OCM} TO V _{O, cm} PERFORMANCE					
V _{OCM} Dynamic Performance					
−3 dB Bandwidth	$V_{0, cm} = 0.1 \text{ V p-p}$		515		MHz
Slew Rate	$V_{O, cm} = 2 V p-p$		250		V/µs
Gain		0.999	1.000	1.001	V/V
V _{OCM} Input Characteristics					
Input Voltage Range		-3.8		+3.8	V
Input Resistance			3.5		ΜΩ
Input Offset Voltage	$V_{OS, cm} = V_{O, cm} - V_{OCM}$; $V_{IP} = V_{IN} = V_{OCM} = 0 V$	-900	±300	+900	μV
Input Voltage Noise	f = 100 kHz		3.5		nV/√Hz
Input Bias Current			1.3	4.5	μΑ
CMRR	$\Delta V_{OCM}/\Delta V_{O, dm}$, $\Delta V_{OCM} = \pm 1 \text{ V}$	74	88		dB

Parameter	Conditions	Min	Тур	Max	Unit
POWER SUPPLY					
Operating Range		+4.5		±6	V
Quiescent Current			24.5	25.5	mA
+PSRR	Change in $+V_5 = \pm 1 \text{ V}$	95	112		dB
-PSRR	Change in $-V_s = \pm 1 \text{ V}$	95	109		dB
OPERATING TEMPERATURE RANGE		-40		+125	°C

$V_s = 5 V$, $V_{OCM} = 2.5 V$

 $T_A = 25^{\circ}\text{C}$, differential gain = 1, $R_{L, dm} = 1 \text{ k}\Omega$, $R_F = R_G = 200 \Omega$, unless otherwise noted. T_{MIN} to $T_{MAX} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$.

Table 2.

Parameter	Conditions	Min	Тур	Max	Unit
DIFFERENTIAL INPUT PERFORMANCE					
Dynamic Performance					
-3 dB Small Signal Bandwidth	$V_{O, dm} = 0.1 V p-p$	330	385		MHz
-3 dB Large Signal Bandwidth	$V_{O, dm} = 2 V p-p$	135	165		MHz
Bandwidth for 0.1 dB Flatness	$V_{O, dm} = 0.1 V p-p$		34		MHz
Slew Rate	$V_{O, dm} = 2 V step$		540		V/µs
Settling Time to 0.01%	$V_{O, dm} = 2 V step$		55		ns
Overdrive Recovery Time	$G = 2$, $V_{IN, dm} = 7 V p-p$ triangle wave		35		ns
Noise/Harmonic Performance					
SFDR	$V_{O, dm} = 2 V p-p, f_C = 1 MHz$		99		dBc
	$V_{O, dm} = 2 V p-p, f_C = 5 MHz, R_L = 800 \Omega$		87		dBc
	$V_{O, dm} = 2 V p-p, f_C = 20 MHz, R_L = 800 \Omega$		75		dBc
Third-Order IMD	$V_{O, dm} = 2 V p-p, f_C = 10.05 MHz \pm 0.05 MHz$		-87		dBc
Input Voltage Noise	f = 100 kHz		2.25		nV/√Hz
Input Current Noise	f = 100 kHz		2.1		pA/√Hz
DC Performance					
Input Offset Voltage	$V_{IP} = V_{IN} = V_{OCM} = 2.5 V$	-500	±150	+500	μV
Input Offset Voltage Drift	T _{MIN} to T _{MAX}		1.25		μV/°C
Input Bias Current	T _{MIN} to T _{MAX}		2.2	7.5	μA
Input Offset Current			0.13	0.5	μΑ
Open-Loop Gain			112		dB
Input Characteristics					
Input Common-Mode Voltage Range		1		4	V
Input Resistance	Differential		600		kΩ
•	Common mode		1.5		ΜΩ
Input Capacitance	Common mode		1.2		рF
CMRR	$\Delta V_{ICM} = \pm 1 \text{ V dc}, R_F = R_G = 10 \text{ k}\Omega$	75	79		dB
Output Characteristics					
Output Voltage Swing	Each single-ended output, $R_F = R_G = 10 \text{ k}\Omega$	$-V_s + 0.15$		$+V_{S}-0.15$	V
	Each single-ended output,	$-V_s + 0.10$		$+V_{S}-0.10$	V
	$R_{L,dm} = open circuit, R_F = R_G = 10 k\Omega$				
Output Current	Each single-ended output		80		mA
Output Balance Error	f = 1 MHz		-70		dB
V _{OCM} TO V _{O, cm} PERFORMANCE					
V _{OCM} Dynamic Performance					
–3 dB Bandwidth	$V_{0, cm} = 0.1 \text{ V p-p}$		440		MHz
Slew Rate	$V_{0, cm} = 2 V p-p$		150		V/µs
Gain		0.999	1.000	1.001	V/V
V _{OCM} Input Characteristics					
Input Voltage Range		1.0		3.8	V
Input Resistance			3.5		ΜΩ
Input Offset Voltage	$V_{OS, cm} = V_{O, cm} - V_{OCM}$; $V_{IP} = V_{IN} = V_{OCM} = 2.5 \text{ V}$	-1.0	±0.45	+1.0	mV
Input Voltage Noise	f = 100 kHz		3.5		nV/√Hz
Input Bias Current			1.3	4.2	μΑ
CMRR	$\Delta V_{OCM}/\Delta V_{O, dm}$, $\Delta V_{OCM} = \pm 1 \text{ V}$	67	79		dB

Parameter	Conditions	Min	Тур	Max	Unit
POWER SUPPLY					
Operating Range		+4.5		±6	V
Quiescent Current			21.5	22.5	mA
+PSRR	Change in $+V_5 = \pm 1 \text{ V}$	86	97		dB
-PSRR	Change in $-V_s = \pm 1 \text{ V}$	92	105		dB
OPERATING TEMPERATURE RANGE		-40		+125	°C

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	12 V
V _{осм}	± V _S
Power Dissipation	See Figure 4
Input Common-Mode Voltage	± V _S
Storage Temperature Range	−65°C to +125°C
Operating Temperature Range	−40°C to +125°C
Lead Temperature (Soldering 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, θ_{JA} is specified for device soldered in circuit board for surface-mount packages.

Table 4.

Package Type	$\boldsymbol{\theta}_{JA}$	Unit
8-Lead SOIC with EP/4-Layer	70	°C/W
8-Lead LFCSP/4-Layer	70	°C/W

Maximum Power Dissipation

The maximum safe power dissipation in the AD8139 package is limited by the associated rise in junction temperature (T_I) on the die. At approximately 150°C, which is the glass transition temperature, the plastic will change its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the AD8139. Exceeding a junction temperature of 175°C for an extended period can result in changes in the silicon devices potentially causing failure.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power is the voltage between the supply pins (V_s) times the quiescent current (I_s). The load current consists of differential and common-mode currents flowing to the load, as well as currents flowing through the external feedback networks and the internal common-mode feedback loop. The internal resistor tap used in the common-mode feedback loop places a 1 k Ω differential load on the output. RMS output voltages should be considered when dealing with ac signals.

Airflow reduces θ_{JA} . In addition, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes reduce the θ_{JA} .

Figure 4 shows the maximum safe power dissipation in the package vs. the ambient temperature for the exposed paddle (EP) 8-lead SOIC ($\theta_{JA} = 70^{\circ}\text{C/W}$) and the 8-lead LFCSP ($\theta_{JA} = 70^{\circ}\text{C/W}$) on a JEDEC standard 4-layer board. θ_{JA} values are approximations.

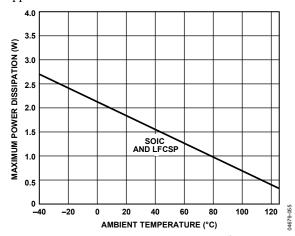


Figure 4. Maximum Power Dissipation vs. Temperature for a 4-Layer Board

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

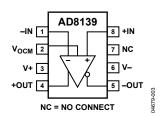


Figure 5. 8-Lead SOIC Pin Configuration

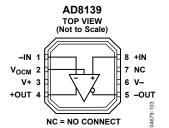


Figure 6. 8-Lead LFCSP Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	-IN	Inverting Input.
2	Vосм	An internal feedback loop drives the output common-mode voltage to be equal to the voltage applied to the V_{OCM} pin, provided the operation of the amplifier remains linear.
3	V+	Positive Power Supply Voltage.
4	+OUT	Positive Side of the Differential Output.
5	-OUT	Negative Side of the Differential Output.
6	V-	Negative Power Supply Voltage.
7	NC	No Internal Connection.
8	+IN	Noninverting Input.
9	Exposed Paddle	Solder exposed paddle on back of package to ground plane or to a power plane.

TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise noted, differential gain = +1, $R_G = R_F = 200~\Omega$, $R_{L,\,dm} = 1~k\Omega$, $V_S = \pm 5~V$, $T_A = 25^{\circ}C$, $V_{OCM} = 0~V$. Refer to the basic test circuit in Figure 57 for the definition of terms.

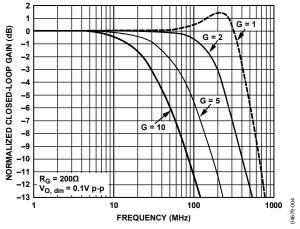


Figure 7. Small Signal Frequency Response for Various Gains

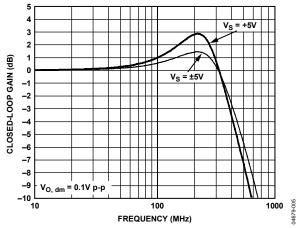


Figure 8. Small Signal Frequency Response for Various Power Supplies

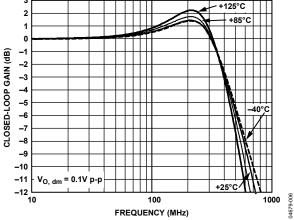


Figure 9. Small Signal Frequency Response at Various Temperatures

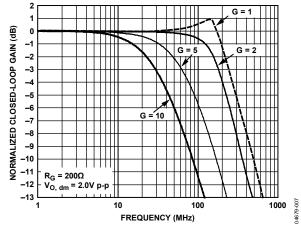


Figure 10. Large Signal Frequency Response for Various Gains

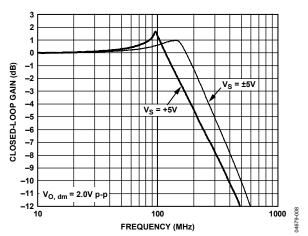


Figure 11. Large Signal Frequency Response for Various Power Supplies

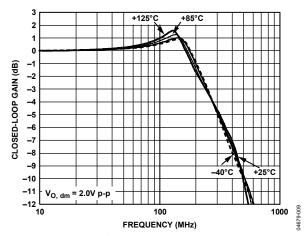


Figure 12. Large Signal Frequency Response at Various Temperatures

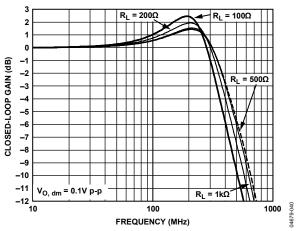


Figure 13. Small Signal Frequency Response for Various Loads

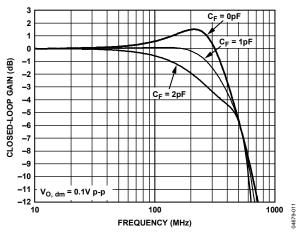


Figure 14. Small Signal Frequency Response for Various CF

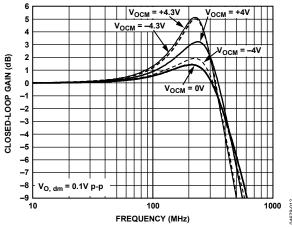


Figure 15. Small Signal Frequency Response at Various Voca

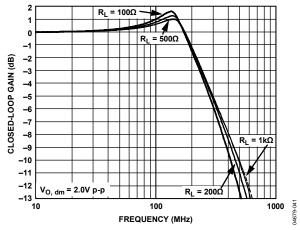


Figure 16. Large Signal Frequency Response for Various Loads

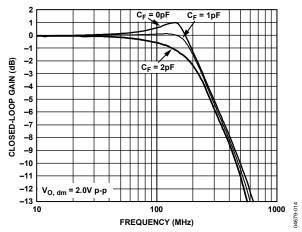


Figure 17. Large Signal Frequency Response for Various C_F

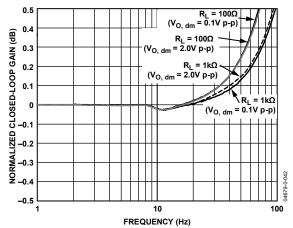


Figure 18. 0.1 dB Flatness for Various Loads and Output Amplitudes

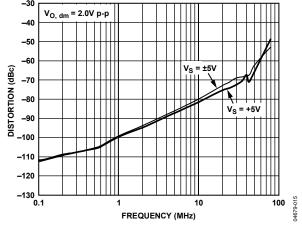


Figure 19. Second Harmonic Distortion vs. Frequency and Supply Voltage

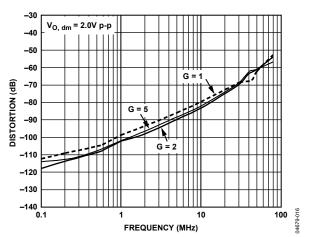


Figure 20. Second Harmonic Distortion vs. Frequency and Gain

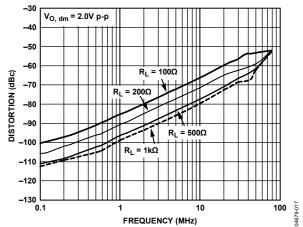


Figure 21. Second Harmonic Distortion vs. Frequency and Load

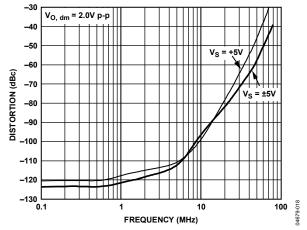


Figure 22. Third Harmonic Distortion vs. Frequency and Supply Voltage

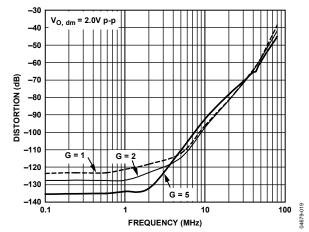


Figure 23. Third Harmonic Distortion vs. Frequency and Gain

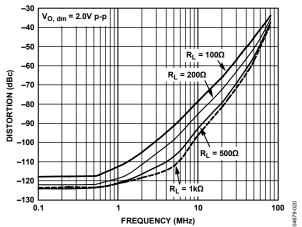


Figure 24. Third Harmonic Distortion vs. Frequency and Load

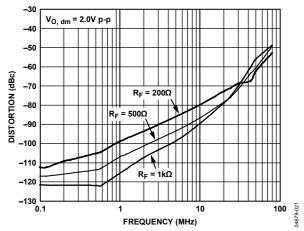


Figure 25. Second Harmonic Distortion vs. Frequency and R_F

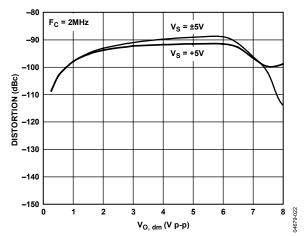


Figure 26. Second Harmonic Distortion vs. Output Amplitude

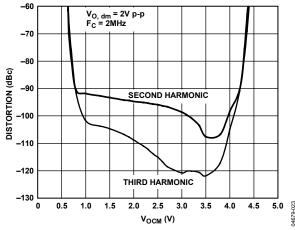


Figure 27. Harmonic Distortion vs. V_{OCM} , $V_S = +5 V$

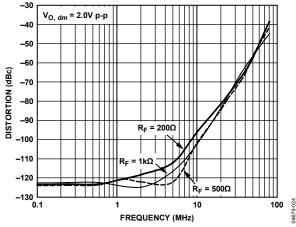


Figure 28. Third Harmonic Distortion vs. Frequency and R_F

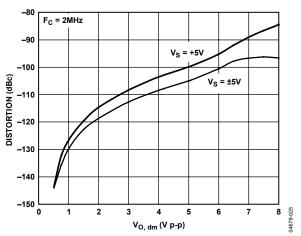


Figure 29. Third Harmonic Distortion vs. Output Amplitude

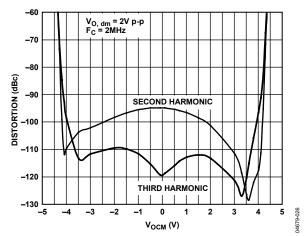


Figure 30. Harmonic Distortion vs. V_{OCM} , $V_S = \pm 5 V$

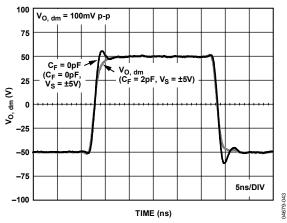


Figure 31. Small Signal Transient Response for Various CF

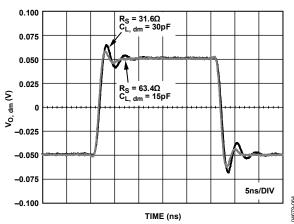


Figure 32. Small Signal Transient Response for Capacitive Loads

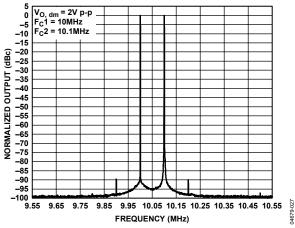


Figure 33. Intermodulation Distortion

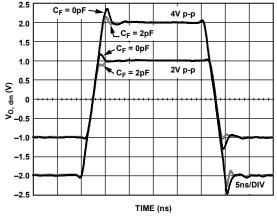


Figure 34. Large Signal Transient Response for Various C_F

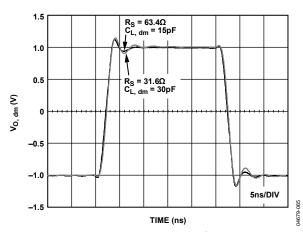


Figure 35. Large Signal Transient Response for Capacitive Loads

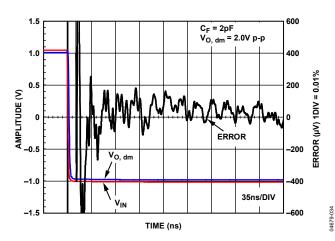


Figure 36. Settling Time (0.01%)

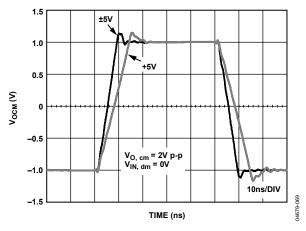


Figure 37. V_{OCM} Large Signal Transient Response

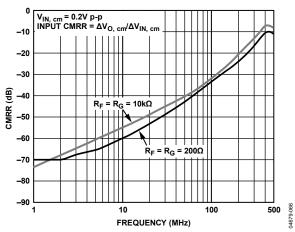


Figure 38. CMRR vs. Frequency

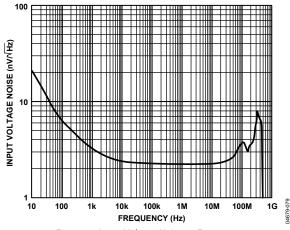


Figure 39. Input Voltage Noise vs. Frequency

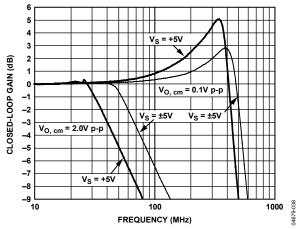


Figure 40. Vocm Frequency Response for Various Supplies

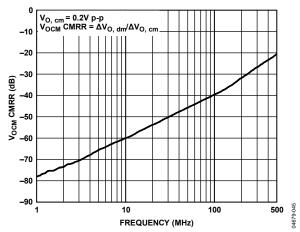


Figure 41. Vocm CMRR vs. Frequency

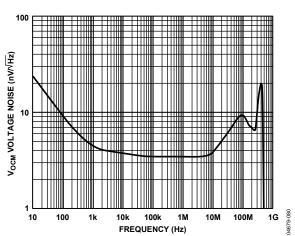


Figure 42. Vocm Voltage Noise vs. Frequency

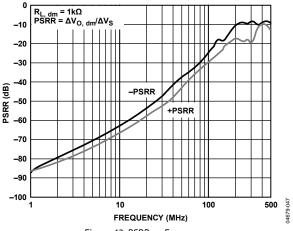


Figure 43. PSRR vs. Frequency

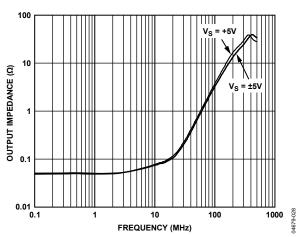


Figure 44. Single-Ended Output Impedance vs. Frequency

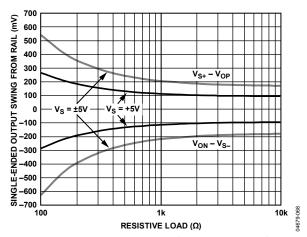


Figure 45. Output Saturation Voltage vs. Output Load

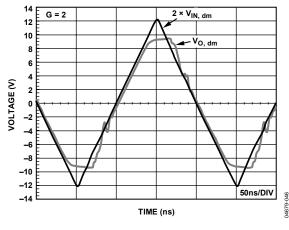


Figure 46. Overdrive Recovery

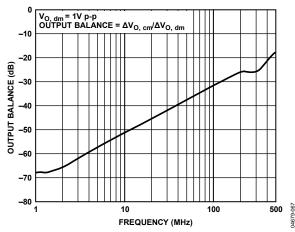


Figure 47. Output Balance vs. Frequency

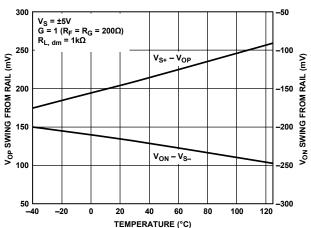


Figure 48. Output Saturation Voltage vs. Temperature

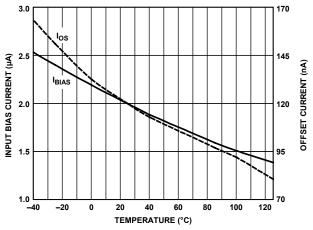


Figure 49. Input Bias and Offset Current vs. Temperature

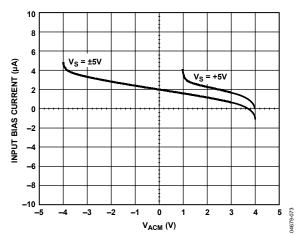


Figure 50. Input Bias Current vs. Input Common-Mode Voltage

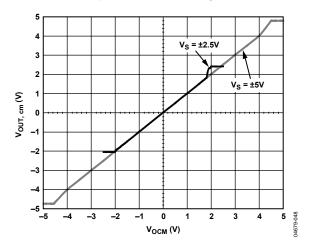


Figure 51. $V_{OUT, cm}$ vs. V_{OCM} Input Voltage

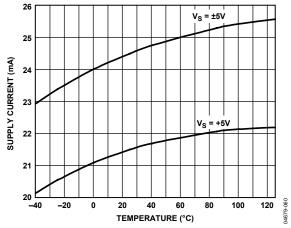


Figure 52. Supply Current vs. Temperature

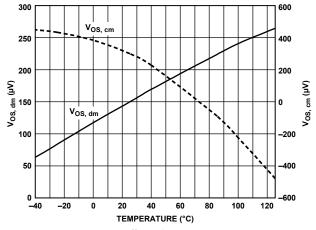


Figure 53. Offset Voltage vs. Temperature

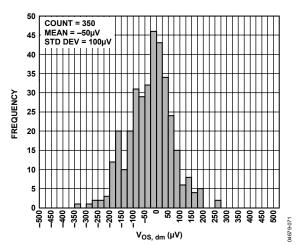


Figure 54. Vos, dm Distribution

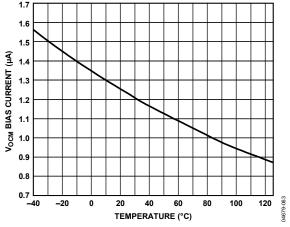


Figure 55. V_{OCM} Bias Current vs. Temperature

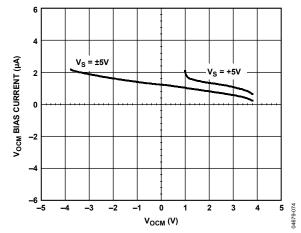


Figure 56. V_{OCM} Bias Current vs. V_{OCM} Input Voltage

TEST CIRCUITS

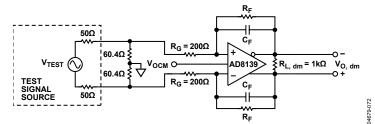


Figure 57. Basic Test Circuit

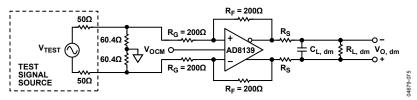


Figure 58. Capacitive Load Test Circuit, G = +1

THEORY OF OPERATION

The AD8139 is a high speed, low noise differential amplifier fabricated on the Analog Devices second-generation eXtra Fast Complementary Bipolar (XFCB) process. It is designed to provide two closely balanced differential outputs in response to either differential or single-ended input signals. Differential gain is set by external resistors, similar to traditional voltage-feedback operational amplifiers. The common-mode level of the output voltage is set by a voltage at the $V_{\rm OCM}$ pin and is independent of the input common-mode voltage. The AD8139 has an H-bridge input stage for high slew rate, low noise, and low distortion operation and rail-to-rail output stages that provide maximum dynamic output range. This set of features allows for convenient single-ended-to-differential conversion, a common need to take advantage of modern high resolution ADCs with differential inputs.

TYPICAL CONNECTION AND DEFINITION OF TERMS

Figure 59 shows a typical connection for the AD8139, using matched external $R_{\rm F}/R_{\rm G}$ networks. The differential input terminals of the AD8139, $V_{\rm AP}$ and $V_{\rm AN}$, are used as summing junctions. An external reference voltage applied to the $V_{\rm OCM}$ terminal sets the output common-mode voltage. The two output terminals, $V_{\rm OP}$ and $V_{\rm ON}$, move in opposite directions in a balanced fashion in response to an input signal.

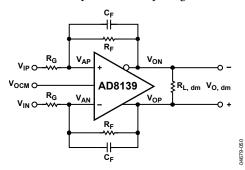


Figure 59. Typical Connection

The differential output voltage is defined as

$$V_{O, dm} = V_{OP} - V_{ON} \tag{1}$$

Common-mode voltage is the average of two voltages. The output common-mode voltage is defined as

$$V_{O, cm} = \frac{V_{OP} + V_{ON}}{2} \tag{2}$$

Output Balance

Output balance is a measure of how well V_{OP} and V_{ON} are matched in amplitude and how precisely they are 180° out of phase with each other. It is the internal common-mode feedback loop that forces the signal component of the output common-mode towards zero, resulting in the near perfectly balanced differential

outputs of identical amplitude and exactly 180° out of phase. The output balance performance does not require tightly matched external components, nor does it require that the feedback factors of each loop be equal to each other. Low frequency output balance is limited ultimately by the mismatch of an on-chip voltage divider, which is trimmed for optimum performance.

Output balance is measured by placing a well-matched resistor divider across the differential voltage outputs and comparing the signal at the midpoint of the divider with the magnitude of the differential output. By this definition, output balance is equal to the magnitude of the change in output common-mode voltage divided by the magnitude of the change in output differential-mode voltage:

Output Balance =
$$\frac{\Delta V_{O, cm}}{\Delta V_{O, dm}}$$
 (3)

The block diagram of the AD8139 in Figure 60 shows the external differential feedback loop ($R_{\text{F}}/R_{\text{G}}$ networks and the differential input transconductance amplifier, G_{DIFF}) and the internal common-mode feedback loop (voltage divider across V_{OP} and V_{ON} and the common-mode input transconductance amplifier, G_{CM}). The differential negative feedback drives the voltages at the summing junctions V_{AN} and V_{AP} to be essentially equal to each other.

$$V_{AN} = V_{AP} \tag{4}$$

The common-mode feedback loop drives the output common-mode voltage, sampled at the midpoint of the two 500 Ω resistors, to equal the voltage set at the V_{OCM} terminal. This ensures that

$$V_{OP} = V_{OCM} + \frac{V_{O, dm}}{2} \tag{5}$$

and

$$V_{ON} = V_{OCM} - \frac{V_{O, dm}}{2} \tag{6}$$

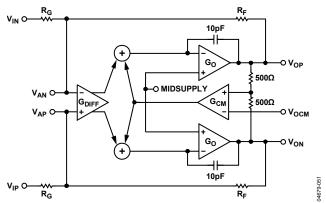


Figure 60. Block Diagram

APPLICATIONS

ESTIMATING NOISE, GAIN, AND BANDWIDTH WITH MATCHED FEEDBACK NETWORKS

Estimating Output Noise Voltage

The total output noise is calculated as the root-sum-squared total of several statistically independent sources. Because the sources are statistically independent, the contributions of each must be individually included in the root-sum-square calculation. Table 6 lists recommended resistor values and estimates of bandwidth and output differential voltage noise for various closed-loop gains. For most applications, 1% resistors are sufficient.

Table 6. Recommended Values of Gain-Setting Resistors and Voltage Noise for Various Closed-Loop Gains

, 01100	, orange reasons real various dissour zeep carries						
Gain	R _G (Ω)	R _F (Ω)	3 dB Bandwidth (MHz)	Total Output Noise (nV/√Hz)			
1	200	200	400	5.8			
2	200	400	160	9.3			
5	200	1 k	53	19.7			
10	200	2 k	26	37			

The differential output voltage noise contains contributions from the input voltage noise and input current noise of the AD8139 as well as those from the external feedback networks.

The contribution from the input voltage noise spectral density is computed as

$$Vo_n 1 = v_n \left(1 + \frac{R_F}{R_G} \right)$$
, or equivalently, v_n / β (7)

where v_n is defined as the input-referred differential voltage noise. This equation is the same as that of traditional op amps.

The contribution from the input current noise of each input is computed as

$$Vo_n 2 = i_n (R_F) \tag{8}$$

where i_n is defined as the input noise current of one input. Each input needs to be treated separately because the two input currents are statistically independent processes.

The contribution from each R_G is computed as

$$Vo_{n3} = \sqrt{4kTR_G} \left(\frac{R_F}{R_G} \right) \tag{9}$$

This result can be intuitively viewed as the thermal noise of each R_G multiplied by the magnitude of the differential gain.

The contribution from each R_F is computed as

$$Vo_n4 = \sqrt{4kTR_F} \tag{10}$$

Voltage Gain

The behavior of the node voltages of the single-ended-to-differential output topology can be deduced from the previous definitions. Referring to Figure 59, ($C_F=0$) and setting $V_{\rm IN}=0$, one can write

$$\frac{V_{IP} - V_{AP}}{R_G} = \frac{V_{AP} - V_{ON}}{R_F} \tag{11}$$

$$V_{AN} = V_{AP} = V_{OP} \left[\frac{R_G}{R_F + R_G} \right] \tag{12}$$

Solving the above two equations and setting $V_{\rm IP}$ to V_i gives the gain relationship for $V_{\rm O,\,dm}/V_i$.

$$V_{OP} - V_{ON} = V_{O, dm} = \frac{R_F}{R_C} V_i$$
 (13)

An inverting configuration with the same gain magnitude can be implemented by simply applying the input signal to $V_{\rm IN}$ and setting $V_{\rm IP}=0$. For a balanced differential input, the gain from $V_{\rm IN,\,dm}$ to $V_{\rm O,\,dm}$ is also equal to $R_{\rm F}/R_{\rm G}$, where $V_{\rm IN,\,dm}=V_{\rm IP}-V_{\rm IN}$.

Feedback Factor Notation

When working with differential amplifiers, it is convenient to introduce the feedback factor β , which is defined as

$$\beta = \frac{R_G}{R_E + R_G} \tag{14}$$

This notation is consistent with conventional feedback analysis and is very useful, particularly when the two feedback loops are not matched.

Input Common-Mode Voltage

The linear range of the V_{AN} and V_{AP} terminals extends to within approximately 1 V of either supply rail. Because V_{AN} and V_{AP} are essentially equal to each other, they are both equal to the input common-mode voltage of the amplifier. Their range is indicated in the Specifications tables as input common-mode range. The voltage at V_{AN} and V_{AP} for the connection diagram in Figure 59 can be expressed as

$$\begin{aligned} V_{AN} &= V_{AP} = V_{ACM} = \\ &\left(\frac{R_F}{R_F + R_G} \times \frac{(V_{IP} + V_{IN})}{2}\right) + \left(\frac{R_G}{R_F + R_G} \times V_{OCM}\right) \end{aligned} \tag{15}$$

where V_{ACM} is the common-mode voltage present at the amplifier input terminals.

Using the β notation, Equation 15 can be written as follows:

$$V_{ACM} = \beta V_{OCM} + (1 - \beta) V_{ICM} \tag{16}$$

or equivalently,

$$V_{ACM} = V_{ICM} + \beta (V_{OCM} - V_{ICM}) \tag{17}$$

where V_{ICM} is the common-mode voltage of the input signal, that is, $V_{ICM} = V_{IP} + V_{IN}/2$.

For proper operation, the voltages at V_{AN} and V_{AP} must stay within their respective linear ranges.

Calculating Input Impedance

The input impedance of the circuit in Figure 59 depends on whether the amplifier is being driven by a single-ended or a differential signal source. For balanced differential input signals, the differential input impedance ($R_{\rm IN,\,dm}$) is simply

$$R_{IN,dm} = 2R_G \tag{18}$$

For a single-ended signal (for example, when $V_{\rm IN}$ is grounded and the input signal drives $V_{\rm IP}$), the input impedance becomes

$$R_{IN} = \frac{R_G}{1 - \frac{R_F}{2(R_G + R_F)}} \tag{19}$$

The input impedance of a conventional inverting op amp configuration is simply $R_{\rm G}$, but it is higher in Equation 19 because a fraction of the differential output voltage appears at the summing junctions, $V_{\rm AN}$ and $V_{\rm AP}$. This voltage partially bootstraps the voltage across the input resistor $R_{\rm G}$, leading to the increased input resistance.

Input Common-Mode Swing Considerations

In some single-ended-to-differential applications, when using a single-supply voltage, attention must be paid to the swing of the input common-mode voltage, V_{ACM} .

Consider the case in Figure 61, where V_{IN} is 5 V p-p swinging about a baseline at ground, and V_{REF} is connected to ground.

The circuit has a differential gain of 1.6 and $\beta=0.38.~V_{\rm ICM}$ has an amplitude of 2.5 V p-p and is swinging about ground. Using the results in Equation 16, the common-mode voltage at the inputs of the AD8139, $V_{\rm ACM}$, is a 1.5 V p-p signal swinging about a baseline of 0.95 V. The maximum negative excursion of $V_{\rm ACM}$ in this case is 0.2 V, which exceeds the lower input common-mode voltage limit.

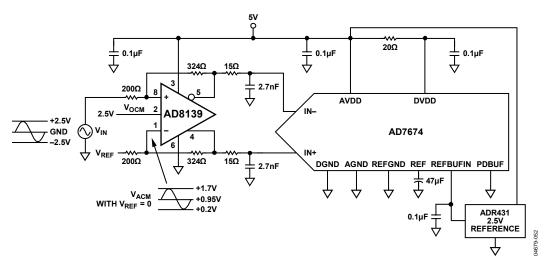
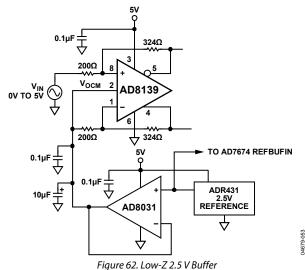


Figure 61. AD8139 Driving AD7674, 18-Bit, 800 kSPS ADC

One way to avoid the input common-mode swing limitation is to bias $V_{\rm IN}$ and $V_{\rm REF}$ at midsupply. In this case, $V_{\rm IN}$ is 5 V p-p swinging about a baseline at 2.5 V, and $V_{\rm REF}$ is connected to a low-Z 2.5 V source. $V_{\rm ICM}$ now has an amplitude of 2.5 V p-p and is swinging about 2.5 V. Using the results in Equation 17, $V_{\rm ACM}$ is calculated to be equal to $V_{\rm ICM}$ because $V_{\rm OCM} = V_{\rm ICM}$. Therefore, $V_{\rm ACM}$ swings from 1.25 V to 3.75 V, which is well within the input common-mode voltage limits of the AD8139. Another benefit seen in this example is that because $V_{\rm OCM} = V_{\rm ACM} = V_{\rm ICM}$ no wasted common-mode current flows. Figure 62 illustrates how to provide the low-Z bias voltage. For situations that do not require a precise reference, a simple voltage divider suffices to develop the input voltage to the buffer.



Another way to avoid the input common-mode swing limitation is to use dual power supplies on the AD8139. In this case, the biasing circuitry is not required.

Bandwidth vs. Closed-Loop Gain

The 3 dB bandwidth of the AD8139 decreases proportionally to increasing closed-loop gain in the same way as a traditional voltage feedback operational amplifier. For closed-loop gains greater than 4, the bandwidth obtained for a specific gain can be estimated as

$$f - 3 \text{ dB}, V_{OUT, dm} = \frac{R_G}{R_G + R_F} \times (300 \text{ MHz})$$
 (20)

or equivalently, $\beta(300 \text{ MHz})$.

This estimate assumes a minimum 90° phase margin for the amplifier loop, which is a condition approached for gains greater than 4. Lower gains show more bandwidth than predicted by the equation due to the peaking produced by the lower phase margin.

Estimating DC Errors

Primary differential output offset errors in the AD8139 are due to three major components: the input offset voltage, the offset between the $V_{\rm AN}$ and $V_{\rm AP}$ input currents interacting with the feedback network resistances, and the offset produced by the dc voltage difference between the input and output common-mode voltages in conjunction with matching errors in the feedback network.

The first output error component is calculated as

$$Vo_e1 = V_{IO}\left(\frac{R_F + R_G}{R_G}\right)$$
, or equivalently as V_{IO}/β (21)

where V_{IO} is the input offset voltage. The input offset voltage of the AD8139 is laser trimmed and guaranteed to be less than 500 μ V.

The second error is calculated as

$$Vo_{e}2 = I_{IO} \left(\frac{R_F + R_G}{R_G} \right) \left(\frac{R_G R_F}{R_F + R_G} \right) = I_{IO} (R_F)$$
 (22)

where I_{IO} is defined as the offset between the two input bias currents.

The third error voltage is calculated as

$$Vo_e3 = \Delta enr \times (V_{ICM} - V_{OCM}) \tag{23}$$

where Δenr is the fractional mismatch between the two feedback resistors.

The total differential offset error is the sum of these three error sources.

Other Impact of Mismatches in the Feedback Networks

The internal common-mode feedback network still forces the output voltages to remain balanced, even when the $R_{\rm F}/R_{\rm G}$ feedback networks are mismatched. However, the mismatch will cause a gain error proportional to the feedback network mismatch.

Ratio-matching errors in the external resistors degrade the ability to reject common-mode signals at the $V_{\rm AN}$ and $V_{\rm IN}$ input terminals, much the same as with a four-resistor difference amplifier made from a conventional op amp. Ratio-matching errors also produce a differential output component that is equal to the $V_{\rm OCM}$ input voltage times the difference between the feedback factors (\$\beta\$s). In most applications using 1% resistors, this component amounts to a differential dc offset at the output that is small enough to be ignored.

Driving a Capacitive Load

A purely capacitive load reacts with the bondwire and pin inductance of the AD8139, resulting in high frequency ringing in the transient response and loss of phase margin. One way to minimize this effect is to place a small resistor in series with each output to buffer the load capacitance (see Figure 58 and Figure 63). The resistor and load capacitance form a first-order, low-pass filter; therefore, the resistor value should be as small as possible. In some cases, the ADCs require small series resistors to be added on their inputs.

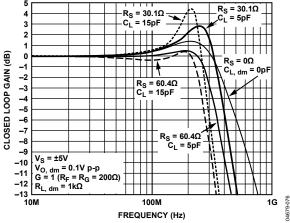


Figure 63. Frequency Response for Various Capacitive Load and Series Resistance

The Typical Performance Characteristics that illustrate transient response vs. the capacitive load were generated using series resistors in each output and a differential capacitive load.

Layout Considerations

Standard high speed PCB layout practices should be adhered to when designing with the AD8139. A solid ground plane is recommended, and good wideband power supply decoupling networks should be placed as close as possible to the supply pins.

To minimize stray capacitance at the summing nodes, the copper in all layers under all traces and pads that connect to the summing nodes should be removed. Small amounts of stray summing-node capacitance cause peaking in the frequency response, and large amounts can cause instability. If some stray summing-node capacitance is unavoidable, its effects can be compensated for by placing small capacitors across the feedback resistors.

Terminating a Single-Ended Input

Controlled impedance interconnections are used in most high speed signal applications, and they require at least one line termination. In analog applications, a matched resistive termination is generally placed at the load end of the line. This section deals with how to properly terminate a single-ended input to the AD8139.

The input resistance presented by the AD8139 input circuitry is seen in parallel with the termination resistor, and its loading effect must be taken into account. The Thevenin equivalent circuit of the driver, its source resistance, and the termination resistance must all be included in the calculation as well. An exact solution to the problem requires the solution of several simultaneous algebraic equations and is beyond the scope of this data sheet. An iterative solution is also possible and simpler, especially considering the fact that standard 1% resistor values are generally used.

Figure 64 shows the AD8139 in a unity-gain configuration driving the AD6645, which is a 14-bit, high speed ADC, and with the following discussion, provides a good example of how to provide a proper termination in a 50 Ω environment.

The termination resistor, R_T , in parallel with the 268 Ω input resistance of the AD8139 circuit (calculated using Equation 19), yields an overall input resistance of 50 Ω that is seen by the signal source. To have matched feedback loops, each loop must have the same R_G if they have the same R_F . In the input (upper) loop, R_G is equal to the 200 Ω resistor in series with the (+) input plus the parallel combination of R_T and the source resistance of 50 Ω . In the upper loop, R_G is therefore equal to 228 Ω . The closest standard 1% value to 228 Ω is 226 Ω and is used for R_G in the lower loop. Greater accuracy could be achieved by using two resistors in series to obtain a resistance closer to 228 Ω .

Things get more complicated when it comes to determining the feedback resistor values. The amplitude of the signal source generator V_S is two times the amplitude of its output signal when terminated in 50 Ω . Therefore, a 2 V p-p terminated amplitude is produced by a 4 V p-p amplitude from V_s. The Thevenin equivalent circuit of the signal source and R_T must be used when calculating the closed-loop gain, because in the upper loop, R_G is split between the 200 Ω resistor and the Thevenin resistance looking back toward the source. The Thevenin voltage of the signal source is greater than the signal source output voltage when terminated in 50 Ω because R_T must always be greater than 50 Ω . In this case, R_T is 61.9 Ω and the Thevenin voltage and resistance are 2.2 V p-p and 28 Ω , respectively. Now the upper input branch can be viewed as a 2.2 V p-p source in series with 228 Ω . Because this is a unitygain application, a 2 V p-p differential output is required, and R_F must therefore be $228 \times (2/2.2) = 206 \Omega$. The closest standard value to this is 205 Ω .

When generating the Typical Performance Characteristics data, the measurements were calibrated to take the effects of the terminations on the closed-loop gain into account. Because this is a single-ended-to-differential application on a single supply, the input common-mode voltage swing must be checked. From Figure 64, $\beta=0.52,$ $V_{\text{OCM}}=2.4$ V, and V_{ICM} is 1.1 V p-p swinging about ground. Using Equation 16, V_{ACM} is calculated to be 0.53 V p-p swinging about a baseline of 1.25 V, and the minimum negative excursion is approximately 1 V.

Exposed Paddle (EP)

The 8-lead SOIC and the 8-lead LFCSP have an exposed paddle on the bottom of the package. To achieve the specified thermal resistance, the exposed paddle must be soldered to one of the PCB planes. The exposed paddle mounting pad should contain several thermal vias within it to ensure a low thermal path to the plane.

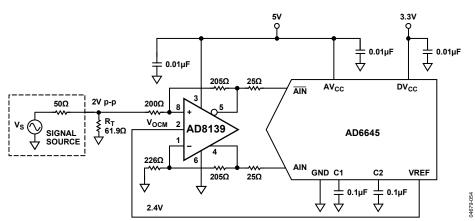
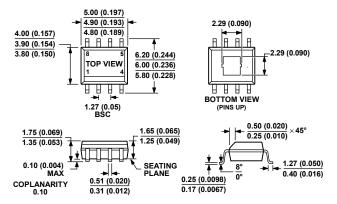


Figure 64. AD8139 Driving AD6645, 14-Bit, 80 MSPS/105 MSPS ADC

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-A A

CONTROLLING DIMENSIONS ARE IN MILLIMETER; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 65. 8-Lead Standard Small Outline Package with Exposed Pad [SOIC_N_EP] Narrow Body (RD-8-1)—Dimensions shown in millimeters and (inches)

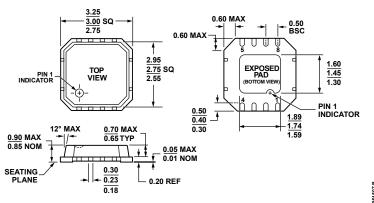


Figure 66. 8-Lead Lead Frame Chip Scale Package [LFCSP_VD] 3 mm × 3 mm Body, Very Thin, Dual Lead (CP-8-2)—Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
AD8139ARD	-40°C to +125°C	8-Lead Small Outline Package with Exposed Pad (SOIC_N_EP)	RD-8-1	
AD8139ARD-REEL	-40°C to +125°C	8-Lead Small Outline Package with Exposed Pad (SOIC_N_EP)	RD-8-1	
AD8139ARD-REEL7	-40°C to +125°C	8-Lead Small Outline Package with Exposed Pad (SOIC_N_EP)	RD-8-1	
AD8139ARDZ ¹	-40°C to +125°C	8-Lead Small Outline Package with Exposed Pad (SOIC_N_EP)	RD-8-1	
AD8139ARDZ-REEL ¹	-40°C to +125°C	8-Lead Small Outline Package with Exposed Pad (SOIC_N_EP)	RD-8-1	
AD8139ARDZ-REEL71	-40°C to +125°C	8-Lead Small Outline Package with Exposed Pad (SOIC_N_EP)	RD-8-1	
AD8139ACP-R2	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP_VD)	CP-8-2	HEB
AD8139ACP-REEL	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP_VD)	CP-8-2	HEB
AD8139ACP-REEL7	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP_VD)	CP-8-2	HEB
AD8139ACPZ-R21	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP_VD)	CP-8-2	HEB#
AD8139ACPZ-REEL ¹	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP_VD)	CP-8-2	HEB#
AD8139ACPZ-REEL7 ¹	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package (LFCSP_VD)	CP-8-2	HEB#

 $^{^1}$ Z = RoHS Compliant Part, # denotes RoHS product may be top or bottom marked.



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Analog Devices Inc.:

AD8139ARD AD8139ARD-REEL